

MITSUBISHI IGBT MODULES
CM200E3U-12H
 HIGH POWER SWITCHING USE
 INSULATED TYPE

CM200E3U-12H



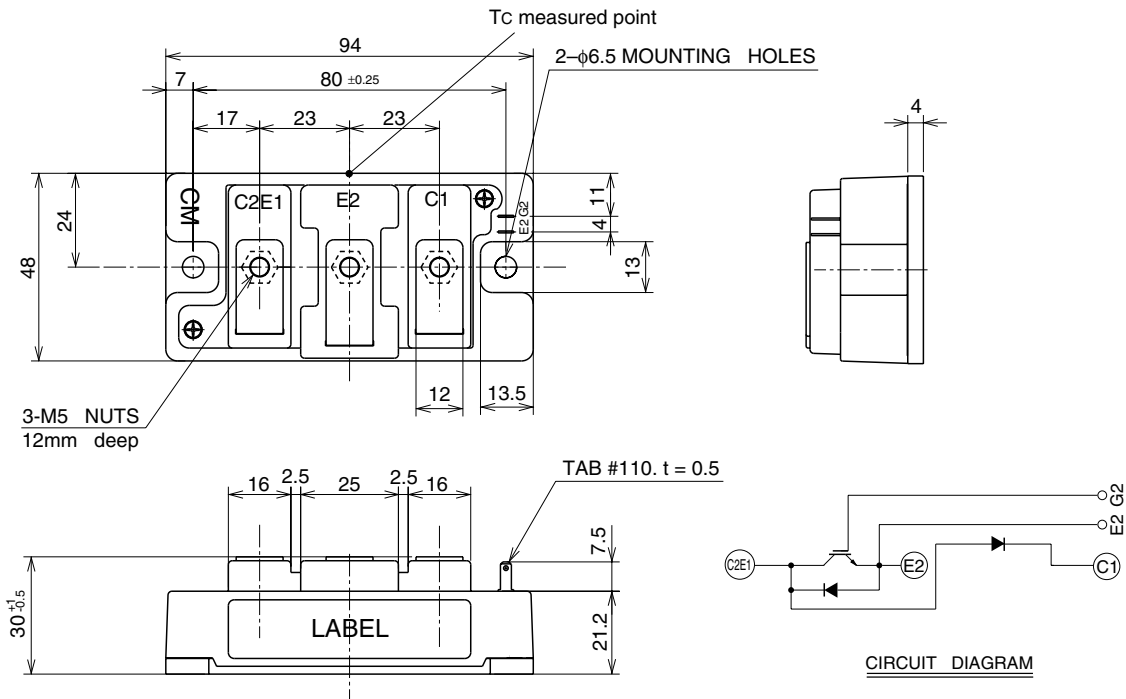
- Ic200A
- VCES600V
- Insulated Type
- 1-element in a pack

APPLICATION

Brake

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



CM200E3U-12H

**HIGH POWER SWITCHING USE
INSULATED TYPE**

MAXIMUM RATINGS (T_j = 25°C, unless otherwise specified)

Symbol	Item	Conditions	Ratings	Unit
V _{CEs}	Collector-emitter voltage	V _{GE} = 0V	600	V
V _{GES}	Gate-emitter voltage	V _{CE} = 0V	±20	V
I _C	Collector current	T _C = 25°C	200	A
I _{CM}		Pulse (Note 1)	400	A
I _E (Note 2)	Emitter current	T _C = 25°C	200	A
I _{EM} (Note 2)		Pulse (Note 1)	400	A
P _C (Note 3)	Maximum collector dissipation	T _C = 25°C	650	W
T _j	Junction temperature	—	-40 ~ +150	°C
T _{stg}	Storage temperature	—	-40 ~ +125	°C
V _{iso}	Isolation voltage	Charged part to base plate, f = 60Hz, AC 1 minute	2500	V _{rms}
—	Mounting torque	Main terminals M5 screw	2.5 ~ 3.5	N·m
		Mounting M6 screw	3.5 ~ 4.5	N·m
—	Weight	Typical value	310	g

ELECTRICAL CHARACTERISTICS (T_j = 25°C, unless otherwise specified)

Symbol	Item	Test Conditions	Limits			Unit
			Min	Typ	Max	
I _{CEs}	Collector cutoff current	V _{CE} = V _{CEs} , V _{GE} = 0V	—	—	1	mA
V _{GE(th)}	Gate-emitter threshold voltage	I _C = 20mA, V _{CE} = 10V	4.5	6	7.5	V
I _{GES}	Gate-leakage current	±V _{GE} = V _{GES} , V _{CE} = 0V	—	—	0.5	μA
V _{CE(sat)}	Collector-emitter saturation voltage	I _C = 200A, V _{GE} = 15V (Note 4)	—	2.4	3.0	V
		T _j = 125°C	—	2.6	—	
C _{ies}	Input capacitance	V _{CE} = 10V V _{GE} = 0V	—	—	17.6	nF
C _{oes}	Output capacitance		—	—	9.6	nF
C _{res}	Reverse transfer capacitance		—	—	2.6	nF
Q _G	Total gate charge	V _{CC} = 300V, I _C = 200A, V _{GE} = 15V	—	400	—	nC
t _{d(on)}	Turn-on delay time	V _{CC} = 300V, I _C = 200A	—	—	150	ns
t _r	Turn-on rise time	V _{GE} = ±15V	—	—	400	ns
t _{d(off)}	Turn-off delay time	R _G = 3.1Ω	—	—	300	ns
t _f	Turn-off fall time	Resistive load	—	—	300	ns
V _{EC} (Note 2)	Emitter-collector voltage	I _E = 200A, V _{GE} = 0V	—	—	2.6	V
t _{rr} (Note 2)	Reverse recovery time	I _E = 200A	—	—	160	ns
Q _{rr} (Note 2)	Reverse recovery charge	die / dt = -400A / μs	—	0.48	—	μC
R _{th(j-c)Q}	Thermal resistance (Note 5)	Junction to case, IGBT part	—	—	0.19	K/W
R _{th(j-c)R}		Junction to case, FWDi part	—	—	0.35	K/W
V _{FM}	Forward voltage	I _F = 200A, Clamp diode part	—	—	2.6	V
t _{rr}	Reverse recovery time	I _F = 200A	—	—	160	ns
Q _{rr}	Reverse recovery charge	dif / dt = -400A / μs, Clamp diode part	—	0.48	—	μC
R _{th(j-c)}	Thermal resistance (Note 5)	Junction to case, Clamp diode part	—	—	0.35	K/W
R _{th(c-f)}	Contact thermal resistance	Case to heat sink, conductive grease applied (Per 1/2 module) (Note 6)	—	0.07	—	K/W

Note 1. Pulse width and repetition rate should be such that the device junction temperature (T_j) does not exceed T_{jmax} rating.

2. I_E, V_{EC}, t_{rr}, Q_{rr} & die/dt represent characteristics of the anti-parallel, emitter-collector free-wheel diode.

3. Junction temperature (T_j) should not increase beyond 150°C.

4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

5. Case temperature (T_C) measured point is shown in page OUTLINE DRAWING.

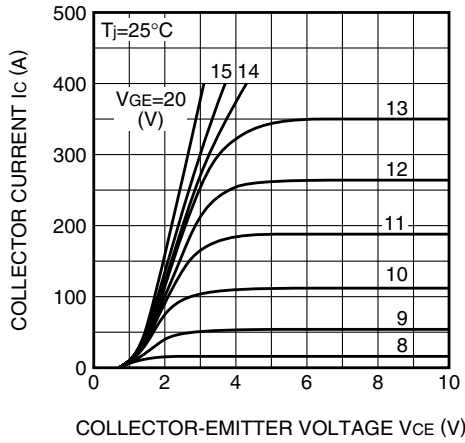
6. Typical value is measured by using thermally conductive grease of λ = 0.9[W/(m · K)].

CM200E3U-12H

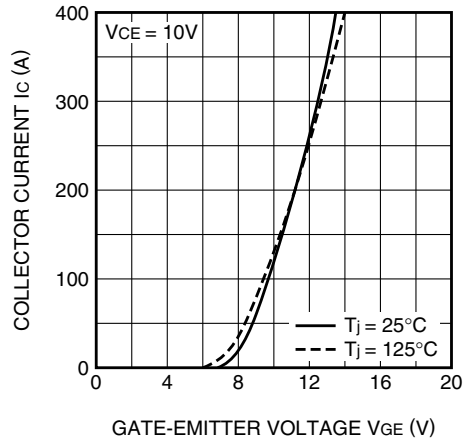
HIGH POWER SWITCHING USE
INSULATED TYPE

PERFORMANCE CURVES

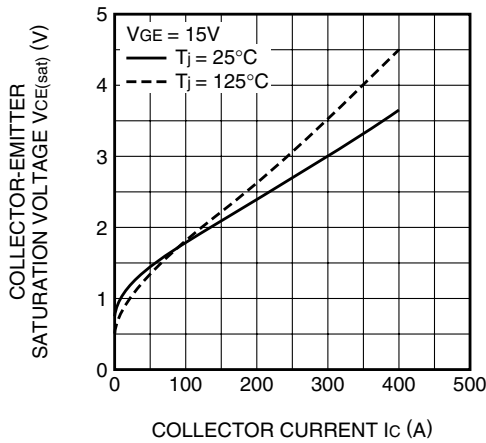
OUTPUT CHARACTERISTICS (TYPICAL)



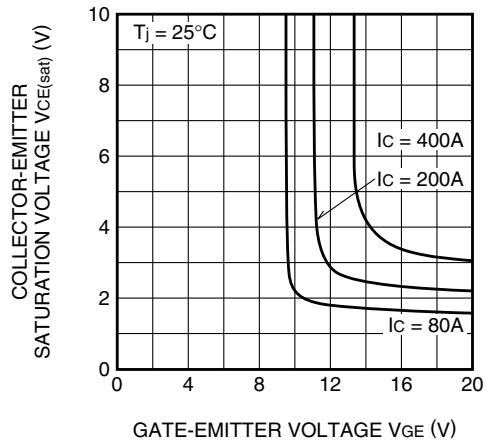
TRANSFER CHARACTERISTICS (TYPICAL)



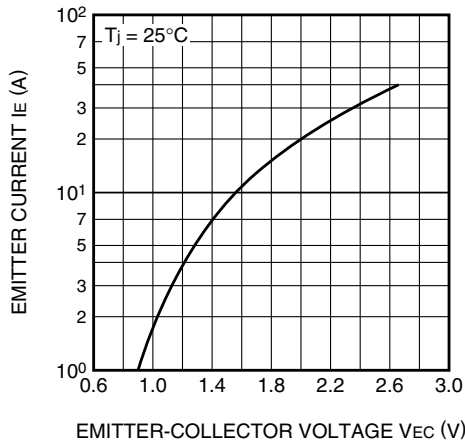
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



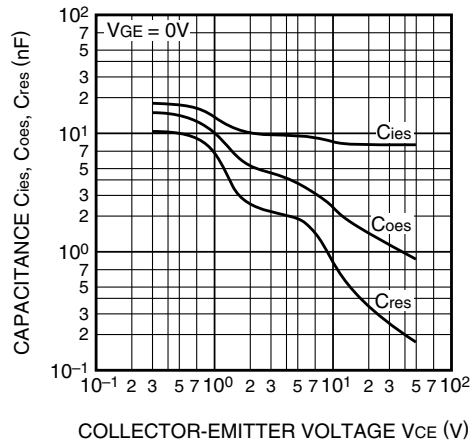
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



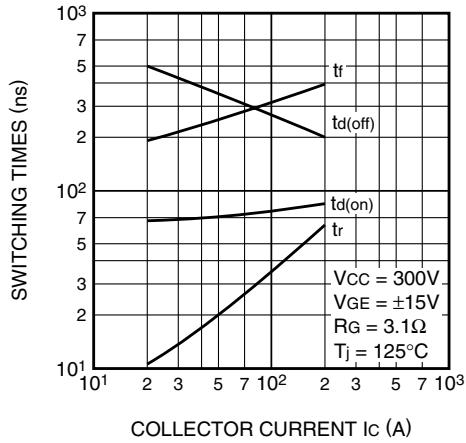
CAPACITANCE CHARACTERISTICS (TYPICAL)



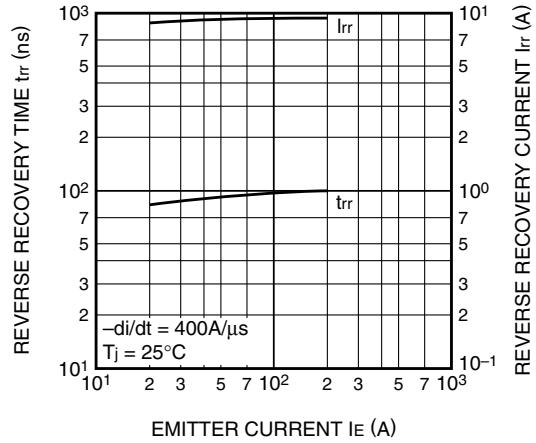
CM200E3U-12H

HIGH POWER SWITCHING USE
INSULATED TYPE

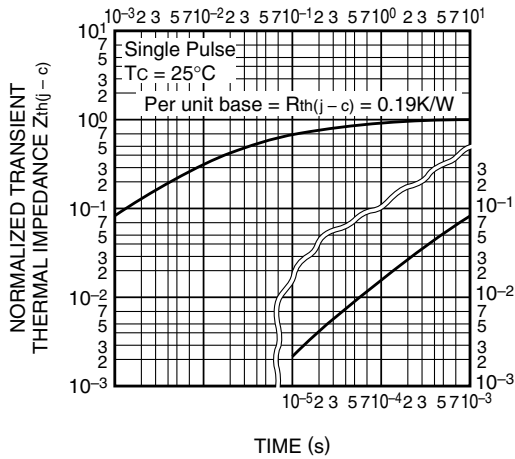
**HALF-BRIDGE
SWITCHING TIME CHARACTERISTICS
(TYPICAL)**



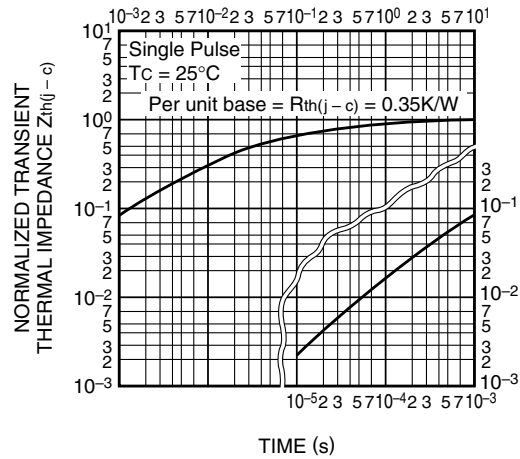
**REVERSE RECOVERY CHARACTERISTICS
OF FREE-WHEEL DIODE
(TYPICAL)**



**TRANSIENT THERMAL
IMPEDANCE CHARACTERISTICS
(IGBT part)**



**TRANSIENT THERMAL
IMPEDANCE CHARACTERISTICS
(FWDi part)**



**GATE CHARGE CHARACTERISTICS
(TYPICAL)**

